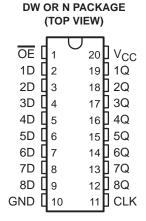
## SN74F574 OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

SDFS005A - D3034, SEPTEMBER 1987 - REVISED OCTOBER 1993

- Eight D-Type Flip-Flops in a Single Package
- 3-State Bus-Driving True Outputs
- Full Parallel Access for Loading
- Buffered Control Inputs
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

#### description

This 8-bit flip-flop features 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.



The eight flip-flops of the SN74F574 are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs will be set to the logic levels that were set up at the data (D) inputs.

A buffered output enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

The output enable  $(\overline{OE})$  does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN74F574 is characterized for operation from 0°C to 70°C.

# FUNCTION TABLE (each flip-flop)

|    | INPUTS     | OUTPUT |       |
|----|------------|--------|-------|
| ŌĒ | CLK        | Q      |       |
| L  | 1          | Н      | Н     |
| L  | $\uparrow$ | L      | L     |
| L  | L          | Χ      | $Q_0$ |
| Н  | X          | Χ      | Z     |

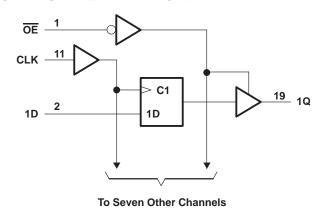


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#### logic symbol†

#### OE ΕN CLK > C1 2 19 1D 1D 1Q 18 3 2D 2Q 17 4 3D **3Q** 5 16 4D 4Q 6 15 5D **5Q** 7 14 6D 6Q 8 13 7D 7Q 9 12 8D 8Q

## logic diagram (positive logic)



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| Supply voltage range, V <sub>CC</sub>                                  |                            |
|--|----------------------------|
| Input voltage range, V <sub>I</sub> (see Note 1)                       | 1.2 V to 7 V               |
| Input current range  | –30 mA to 5 mA             |
| Voltage range applied to any output in the disabled or power-off state |                            |
| Voltage range applied to any output in the high state                  | $-0.5 \text{ V to V}_{CC}$ |
| Current into any output in the low state                               | 48 mA                      |
| Operating free-air temperature range                                   | 0°C to 70°C                |
| Storage temperature range  | 65°C to 150°C              |

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

|     |                                | MIN | NOM | MAX  | UNIT |
|-----|--------------------------------|-----|-----|------|------|
| Vcc | Supply voltage                 | 4.5 | 5   | 5.5  | V    |
| VIH | High-level input voltage       | 2   |     |      | V    |
| VIL | Low-level input voltage        |     |     | 0.8  | V    |
| lıĸ | Input clamp current            |     |     | - 18 | mA   |
| IOH | High-level output current      |     |     | -3   | mA   |
| loL | Low-level output current       |     |     | 24   | mA   |
| TA  | Operating free-air temperature | 0   |     | 70   | °C   |

NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST C                     | CONDITIONS                                 | MIN  | TYP <sup>†</sup> | MAX   | UNIT |
|------------------|----------------------------|--|------|------------------|-------|------|
| VIK              | V <sub>CC</sub> = 4.5 V,   | I <sub>I</sub> = – 18 mA                   |      |                  | - 1.2 | V    |
|                  | V <sub>CC</sub> = 4.5 V    | I <sub>OH</sub> = – 1 mA                   | 2.5  | 3.4              |       |      |
| Voн              | VCC = 4.5 V                | I <sub>OH</sub> = - 3 mA                   | 2.4  | 3.3              |       | V    |
|                  | $V_{CC} = 4.75 \text{ V},$ | $I_{OH} = -1 \text{ mA to } -3 \text{ mA}$ | 2.7  |                  |       |      |
| V <sub>OL</sub>  | V <sub>CC</sub> = 4.5 V,   | I <sub>OL</sub> = 24 mA                    |      | 0.35             | 0.5   | V    |
| lozh             | $V_{CC} = 5.5 \text{ V},$  | V <sub>O</sub> = 2.7 V                     |      |                  | 50    | μΑ   |
| I <sub>OZL</sub> | $V_{CC} = 5.5 \text{ V},$  | V <sub>O</sub> = 0.5 V                     |      |                  | -50   | μΑ   |
| lį               | $V_{CC} = 5.5 \text{ V},$  | V <sub>I</sub> = 7 V                       |      |                  | 0.1   | mA   |
| I <sub>IH</sub>  | $V_{CC} = 5.5 \text{ V},$  | V <sub>I</sub> = 2.7 V                     |      |                  | 20    | μΑ   |
| I <sub>IL</sub>  | $V_{CC} = 5.5 \text{ V},$  | V <sub>I</sub> = 0.5 V                     |      |                  | - 0.6 | mA   |
| los <sup>‡</sup> | V <sub>CC</sub> = 5.5 V,   | VO = 0                                     | - 60 |                  | - 150 | mA   |
| Iccz             | V <sub>CC</sub> = 5.5 V,   | See Note 2                                 |      | 55               | 86    | mA   |

### timing requirements

|                 |                              |           | V <sub>CC</sub> : | = 5 V,<br>25°C | V <sub>CC</sub> = 4.5<br>T <sub>A</sub> = MIN t | UNIT |     |
|-----------------|------------------------------|-----------|-------------------|----------------|---|------|-----|
|                 |                              |           | MIN               | MAX            | MIN   | MAX  |     |
| fclock          | Clock frequency              |           | 0                 | 100            | 0   | 100  | MHz |
|                 | Pulse duration               | CLK high  | 7                 |                | 7   |      | no  |
| t <sub>W</sub>  | Fulse duration               | CLK low   | 6                 |                | 6   |      | ns  |
|                 | Ontone there is a force OLIC | Data high | 2                 |                | 2   |      |     |
| t <sub>su</sub> | Setup time before CLK↑       | Data low  | 2                 |                | 2   |      | ns  |
| +.              | Hold time after CLK↑         | Data high | 2                 |                | 2   |      |     |
| <sup>t</sup> h  | Hold time after OLK!         | Data low  | 2                 |                | 2   |      | ns  |

#### switching characteristics (see Note 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | C <sub>L</sub><br>R <sub>L</sub> | C = 5 V,<br>= 50 pF<br>= 500 Ω<br>= 25°C | ,    | $V_{CC} = 4.5$ $C_L = 50 \text{ pF}$ $R_L = 500 \Omega$ $T_A = \text{MIN t}$ | =,<br><u>)</u> , | UNIT |
|------------------|-----------------|----------------|----------------------------------|--|------|--|------------------|------|
|                  |                 |                | MIN                              | TYP                                      | MAX  | MIN  | MAX              |      |
| fmax             |                 |                | 100                              |  |      | 100  |                  | MHz  |
| t <sub>PLH</sub> | CLK             | Any O          | 3.2                              | 6.1                                      | 8.5  | 3.2  | 10               | ns   |
| <sup>t</sup> PHL | CLK             | Any Q          | 3.2                              | 6.1                                      | 8.5  | 3.2  | 10               | 115  |
| <sup>t</sup> PZH | ŌĒ              | Any Q          | 1.2                              | 8.6                                      | 11.5 | 1.2  | 12.5             | ne   |
| t <sub>PZL</sub> | OE              | Ally Q         | 1.2                              | 4.9                                      | 7.5  | 1.2  | 8.5              | ns   |
| <sup>t</sup> PHZ | ŌĒ              | Any Q          | 1.2                              | 4.9                                      | 7    | 1.2  | 8                | nc   |
| <sup>t</sup> PLZ | OL .            | Ally Q         | 1.2                              | 3.9                                      | 5.5  | 1.2  | 6.5              | ns   |

<sup>§</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.



<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: I<sub>CCZ</sub> is measured with  $\overline{\text{OE}}$  at 4.5 V and all other inputs grounded.

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#### PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan            | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|----------------------|---------|
| SN74F574DW       | LIFEBUY    | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | F574                 |         |
| SN74F574DWR      | ACTIVE     | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | F574                 | Samples |
| SN74F574N        | ACTIVE     | PDIP         | N                  | 20   | 20             | RoHS &<br>Non-Green | NIPDAU                        | N / A for Pkg Type | 0 to 70      | SN74F574N            | Samples |
| SN74F574NSR      | ACTIVE     | SO           | NS                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM | 0 to 70      | 74F574               | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# PACKAGE OPTION ADDENDUM

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# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





| A0 | <u> </u>  |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74F574DWR | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74F574NSR | SO              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |

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#### \*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74F574DWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74F574NSR | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |

# PACKAGE MATERIALS INFORMATION

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#### **TUBE**



#### \*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74F574DW | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74F574N  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |

### **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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